

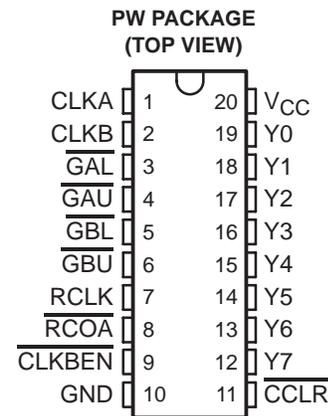
# SN74LV8154-EP DUAL 16 BIT BINARY COUNTER WITH 3-STATE OUTPUT REGISTERS

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- **Controlled Baseline**
  - One Assembly Site
  - One Test Site
  - One Fabrication Site
- **Extended Temperature Performance of –55°C to 125°C**
- **Enhanced Diminishing Manufacturing Sources (DMS) Support**
- **Enhanced Product-Change Notification**
- **Qualification Pedigree†**
- **Can Be Used as Two 16 Bit Counters or a Single 32 Bit Counter**
- **2-V to 5.5-V V<sub>CC</sub> Operation**
- **Max t<sub>pd</sub> of 25 ns at 5 V (RCLK to Y)**
- **Typical V<sub>OLP</sub> (Output Ground Bounce) <0.7 V at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C**
- **Typical V<sub>OHV</sub> (Output V<sub>OH</sub> Undershoot) >4.4 V at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C**
- **I<sub>off</sub> Supports Partial-Power-Down Mode Operation**
- **Latch-Up Performance Exceeds 250 mA Per JESD 17**

- **ESD Protection Exceeds JESD 22**
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

† Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.



## description/ordering information

The SN74LV8154 is a dual 16 bit binary counter with 3-state output registers, designed for 2-V to 5.5-V V<sub>CC</sub> operation.

This 16 bit counter (A or B) feeds a 16 bit storage register and each storage register is further divided into an upper byte and lower byte. The  $\overline{\text{GAL}}$ ,  $\overline{\text{GAU}}$ ,  $\overline{\text{GBL}}$ , and  $\overline{\text{GBU}}$  inputs are used to select the byte that needs to be output at Y0–Y7. CLKA is the clock for A counter and CLKB is the clock for B counter. RCLK is the clock for the A and B storage registers. All three clock signals are positive-edge triggered.

A 32 bit counter can be realized by connecting CLKA and CLKB together and by connecting  $\overline{\text{RCOA}}$  to  $\overline{\text{CLKBEN}}$ . To ensure the high-impedance state during power up or power down,  $\overline{\text{GAL}}$ ,  $\overline{\text{GAU}}$ ,  $\overline{\text{GBL}}$ , and  $\overline{\text{GBU}}$  should be tied to V<sub>CC</sub> through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

This device is fully specified for partial-power-down applications using I<sub>off</sub>. The I<sub>off</sub> circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

## ORDERING INFORMATION†

T <sub>A</sub>	PACKAGE‡		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–55°C to 125°C	TSSOP – PW	Tape and reel	SN74LV8154MPWREP	LV8154ME

† For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at [www.ti.com](http://www.ti.com).

‡ Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/packaging](http://www.ti.com/packaging).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS  
INSTRUMENTS**

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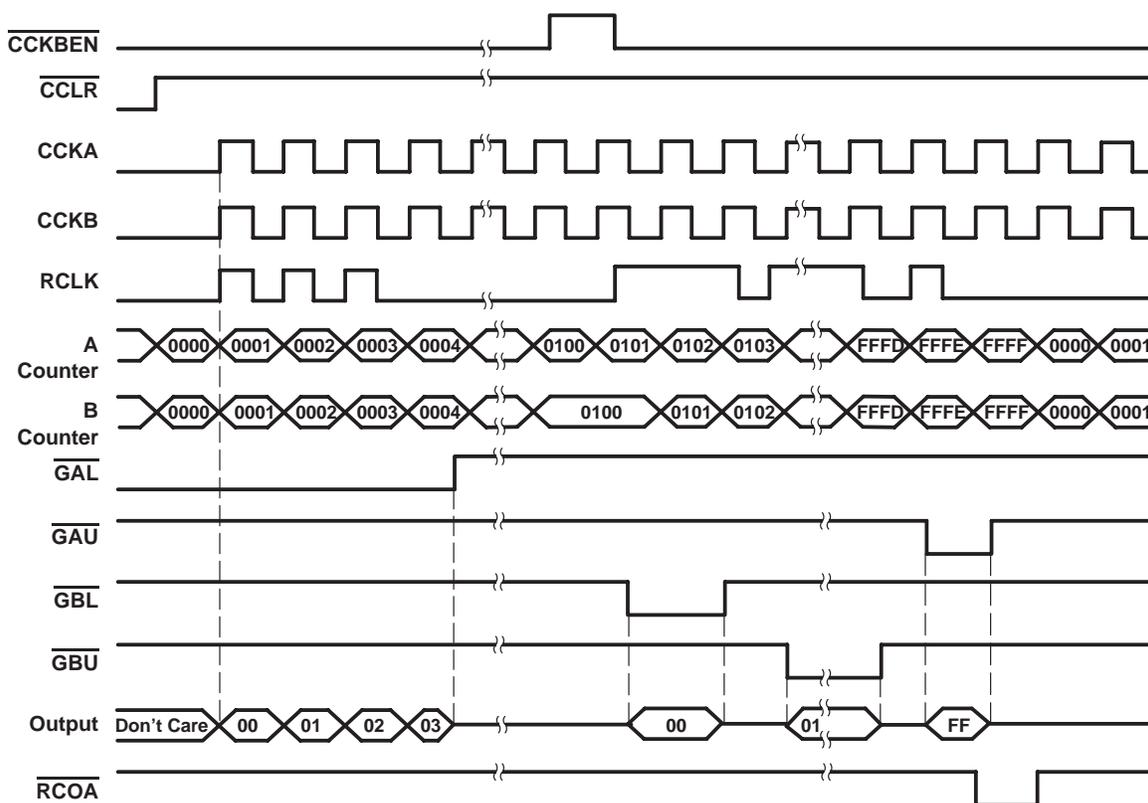
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**FUNCTION TABLE**  
 (each buffer)

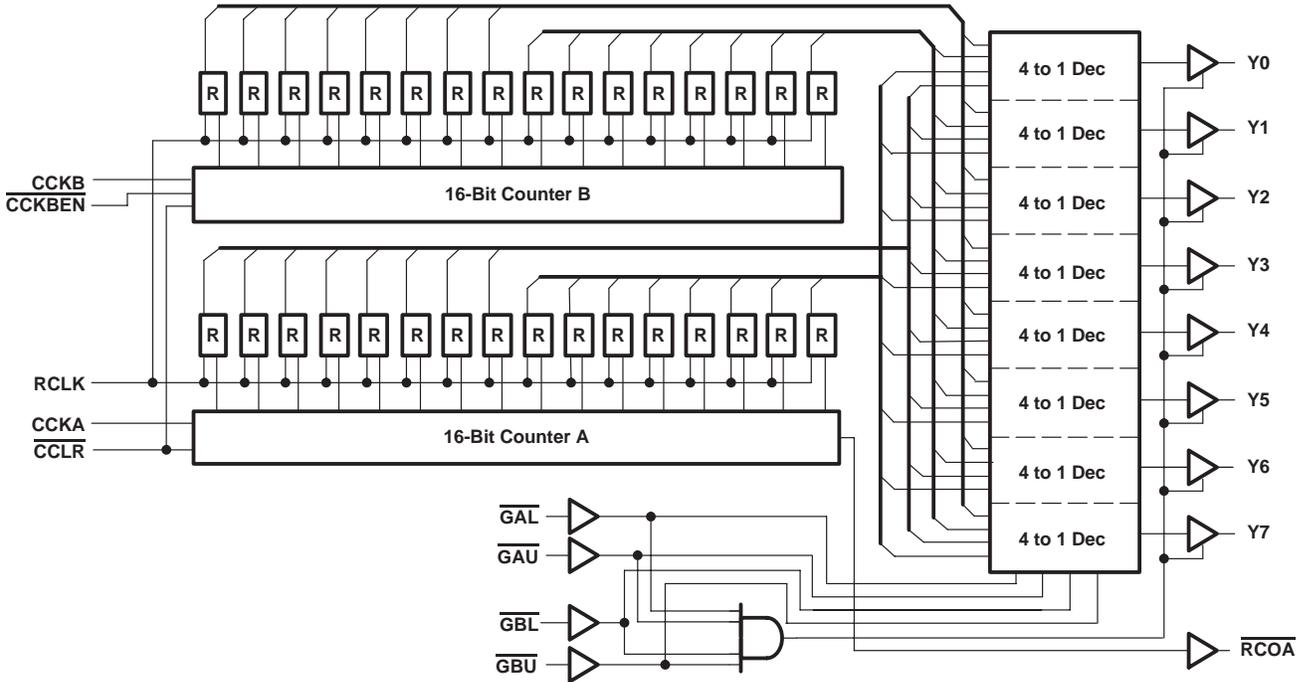
INPUTS				OUTPUT Y <sub>n</sub>
$\overline{\text{GAL}}$	$\overline{\text{GAU}}$	$\overline{\text{GBL}}$	$\overline{\text{GBU}}$	
L	H	H	H	Lower byte in A register
H	L	H	H	Upper byte in A register
H	H	L	H	Lower byte in B register
H	H	H	L	Upper byte in B register
H	H	H	H	Z

Combinations of  $\overline{\text{GAL}}$ ,  $\overline{\text{GAU}}$ ,  $\overline{\text{GBL}}$ , and  $\overline{\text{GBU}}$ , other than those shown above, are prohibited. If more than one input is L at the same time, the output data (Y0–Y7) may be invalid.

**timing diagram**



**block diagram**



**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†**

Supply voltage range, $V_{CC}$ .....	-0.5 V to 7 V
Input voltage range, $V_I$ (see Note 1) .....	-0.5 V to 7 V
Voltage range applied to any output in the high-impedance or power-off state, $V_O$ (see Note 1) .....	-0.5 V to 7 V
Output voltage range, $V_O$ (see Note 1 and Note 2) .....	-0.5 V to $V_{CC} + 0.5$ V
Input clamp current, $I_{IK}$ ( $V_I < 0$ V) .....	-20 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ V) .....	-50 mA
Continuous output current, $I_O$ ( $V_O = 0$ V to $V_{CC}$ ) .....	$\pm 35$ mA
Continuous current through $V_{CC}$ or GND .....	$\pm 70$ mA
Package thermal impedance, $\theta_{JA}$ (see Note 3): .....	83°C/W
Storage temperature range, $T_{stg}$ .....	-65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.  
 2. This value is limited to 5.5 V maximum.  
 3. The package thermal impedance is calculated in accordance with JESD 51-7.

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**recommended operating conditions (see Note 4)**

		V <sub>CC</sub>	MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage		2	5.5	V
V <sub>IH</sub>	High-level input voltage	2 V	1.5		V
		3 V to 3.6 V	V <sub>CC</sub> × 0.7		
		4.5 V to 5.5 V	V <sub>CC</sub> × 0.7		
V <sub>IL</sub>	Low-level input voltage	2 V		0.5	V
		3 V to 3.6 V		V <sub>CC</sub> × 0.3	
		4.5 V to 5.5 V		V <sub>CC</sub> × 0.3	
V <sub>I</sub>	Input voltage		0	5.5	V
V <sub>O</sub>	Output voltage	High or low state	0	V <sub>CC</sub>	V
		3-state	0	5.5	
I <sub>OH</sub>	Y <sub>n</sub> outputs	2 V		-50	μA
		3 V to 3.6 V		-6	mA
		4.5 V to 5.5 V		-12	
	$\overline{\text{RCOA}}$	2 V		-50	μA
		3 V to 3.6 V		-6	mA
		4.5 V to 5.5 V		-12	
I <sub>OL</sub>	Y <sub>n</sub> outputs	2 V		50	μA
		3 V to 3.6 V		6	mA
		4.5 V to 5.5 V		12	
	$\overline{\text{RCOA}}$	2 V		50	μA
		3 V to 3.6 V		6	mA
		4.5 V to 5.5 V		12	
Δt/Δv	Input transition rise or fall rate	3 V to 3.6 V		100	ns/V
		4.5 V to 5.5 V		20	
T <sub>A</sub>	Operating free-air temperature		-55	125	°C

NOTE 4: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. See the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V <sub>CC</sub>	MIN	TYP	MAX	UNIT
V <sub>OH</sub>	Y <sub>n</sub>	I <sub>OH</sub> = -50 μA	2 V	1.9			V
		I <sub>OH</sub> = -6 mA	3 V	2.48			
		I <sub>OH</sub> = -12 mA	4.5 V	3.8			
	$\overline{\text{RCOA}}$	I <sub>OH</sub> = -50 μA	2 V	1.9			
		I <sub>OH</sub> = -6 mA	3 V	2.48			
		I <sub>OH</sub> = -12 mA	4.5 V	3.8			
V <sub>OL</sub>	Y <sub>n</sub>	I <sub>OL</sub> = 50 μA	2 V			0.1	V
		I <sub>OL</sub> = 6 mA	3 V			0.44	
		I <sub>OL</sub> = 12 mA	4.5 V			0.55	
	$\overline{\text{RCOA}}$	I <sub>OL</sub> = 50 μA	2 V			0.1	
		I <sub>OL</sub> = 6 mA	3 V			0.44	
		I <sub>OL</sub> = 12 mA	4.5 V			0.55	
I <sub>I</sub>		V <sub>I</sub> = 5.5 V or GND	0 V to 5.5 V			±1	μA
I <sub>OZ</sub>		V <sub>O</sub> = V <sub>CC</sub> or GND	5.5 V			±5	μA
I <sub>CC</sub>		V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0	5.5 V			20	μA
I <sub>off</sub>		V <sub>I</sub> or V <sub>O</sub> = 0 V to 5.5 V	0 V			5	μA
C <sub>i</sub>		V <sub>I</sub> = V <sub>CC</sub> or GND	5 V		3		pF
C <sub>o</sub>		V <sub>O</sub> = V <sub>CC</sub> or GND	5 V		5		pF

timing requirements over recommended operating free-air temperature range, V<sub>CC</sub> = 3.3 V ± 0.3 V (unless otherwise noted) (see Figure 1)

			MIN	MAX	UNIT
t <sub>w</sub>	Pulse duration	CLKA, CLKB, and RCLK high or low	10		ns
		$\overline{\text{CCLR}}$ low	22		
t <sub>su</sub>	Setup time	$\overline{\text{CLKBEN}}$ low before CLKB↑	13		ns
		$\overline{\text{CCLR}}$ high (inactive) before CLKA↑ or CLKB↑	13		
		CLKA↑ or CLKB↑ before RCLK↑	13		
		RCLK↑ before $\overline{\text{GAL}}$ , $\overline{\text{GAU}}$ , $\overline{\text{GBL}}$ , or $\overline{\text{GBU}}$ low	13		
		$\overline{\text{GAL}}$ , $\overline{\text{GAU}}$ , $\overline{\text{GBL}}$ , or $\overline{\text{GBU}}$ high (inactive) before RCLK↑	13		
t <sub>h</sub>	Hold time	$\overline{\text{CLKBEN}}$ low after CLKB↑	0		ns
		CLKA or CLKB after RCLK	0		
t <sub>z</sub> <sup>†</sup>	Z-period	$\overline{\text{GAL}}$ , $\overline{\text{GAU}}$ , $\overline{\text{GBL}}$ , and $\overline{\text{GBU}}$ all high before one of them switches low	200		ns

<sup>†</sup> t<sub>z</sub> condition: C<sub>L</sub> = 50 pF, R<sub>L</sub> = 1 kΩ



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timing requirements over recommended operating free-air temperature range,  $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$  (unless otherwise noted) (see Figure 1)

			MIN	MAX	UNIT
$t_w$	Pulse duration	CLKA, CLKB, and RCLK high or low	10		ns
		$\overline{\text{CCLR}}$ low	20		
$t_{su}$	Setup time	$\overline{\text{CLKBEN}}$ low before CLKB $\uparrow$	10		ns
		$\overline{\text{CCLR}}$ high (inactive) before CLKA $\uparrow$ or CLKB $\uparrow$	10		
		CLKA $\uparrow$ or CLKB $\uparrow$ before RCLK $\uparrow$	10		
		RCLK $\uparrow$ before $\overline{\text{GAL}}$ , $\overline{\text{GAU}}$ , $\overline{\text{GBL}}$ , or $\overline{\text{GBU}}$ low	10		
		$\overline{\text{GAL}}$ , $\overline{\text{GAU}}$ , $\overline{\text{GBL}}$ , or $\overline{\text{GBU}}$ high (inactive) before RCLK $\uparrow$	10		
$t_h$	Hold time	$\overline{\text{CLKBEN}}$ low after CLKB $\uparrow$	0		ns
		CLKA or CLKB after RCLK	0		
$t_z^\dagger$	Z period	$\overline{\text{GAL}}$ , $\overline{\text{GAU}}$ , $\overline{\text{GBL}}$ , and $\overline{\text{GBU}}$ all high before one of them switches low	200		ns

$^\dagger t_z$  condition:  $C_L = 50\text{ pF}$ ,  $R_L = 1\text{ k}\Omega$

switching characteristics over recommended operating free-air temperature range,  $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$  (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	$T_A = 25^\circ\text{C}$	MIN	MAX	UNIT
				TYP			
$f_{MAX}$			$C_L = 50\text{ pF}$		25		MHz
$t_{pd}$	RCLK	Y	$C_L = 50\text{ pF}$	25	1	42	ns
	CLKA	$\overline{\text{RCOA}}$		28	1	46	
$t_{PLH}$	$\overline{\text{CCLR}}$	$\overline{\text{RCOA}}$		20	1	35	ns
$t_{en}$	$\overline{\text{GAL}}$ , $\overline{\text{GAU}}$ , $\overline{\text{GBL}}$ , $\overline{\text{GBU}}$	Y		30	1	50	ns
$t_{dis}$	$\overline{\text{GAL}}$ , $\overline{\text{GAU}}$ , $\overline{\text{GBL}}$ , $\overline{\text{GBU}}$	Y		14	1	24	ns

switching characteristics over recommended operating free-air temperature range,  $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$  (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	$T_A = 25^\circ\text{C}$	MIN	MAX	UNIT
				TYP			
$f_{MAX}$			$C_L = 50\text{ pF}$		25		MHz
$t_{pd}$	RCLK	Y	$C_L = 50\text{ pF}$	16	1	27	ns
	CLKA	$\overline{\text{RCOA}}$		17	1	28	
$t_{PLH}$	$\overline{\text{CCLR}}$	$\overline{\text{RCOA}}$		13	1	21	ns
$t_{en}$	$\overline{\text{GAL}}$ , $\overline{\text{GAU}}$ , $\overline{\text{GBL}}$ , $\overline{\text{GBU}}$	Y		18	1	30	ns
$t_{dis}$	$\overline{\text{GAL}}$ , $\overline{\text{GAU}}$ , $\overline{\text{GBL}}$ , $\overline{\text{GBU}}$	Y		9	1	16	ns



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**noise characteristics,  $V_{CC} = 5\text{ V}$ ,  $C_L = 50\text{ pF}$**

PARAMETER		$T_A = 25^\circ\text{C}$	UNIT
		TYP	
$V_{OL(P)}$	Quiet output, maximum dynamic $V_{OL}$	0.7	V
$V_{OL(V)}$	Quiet output, minimum dynamic $V_{OL}$	-0.75	V
$V_{OH(V)}$	Quiet output, minimum dynamic $V_{OH}$	4.4	V

**operating characteristics,  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$**

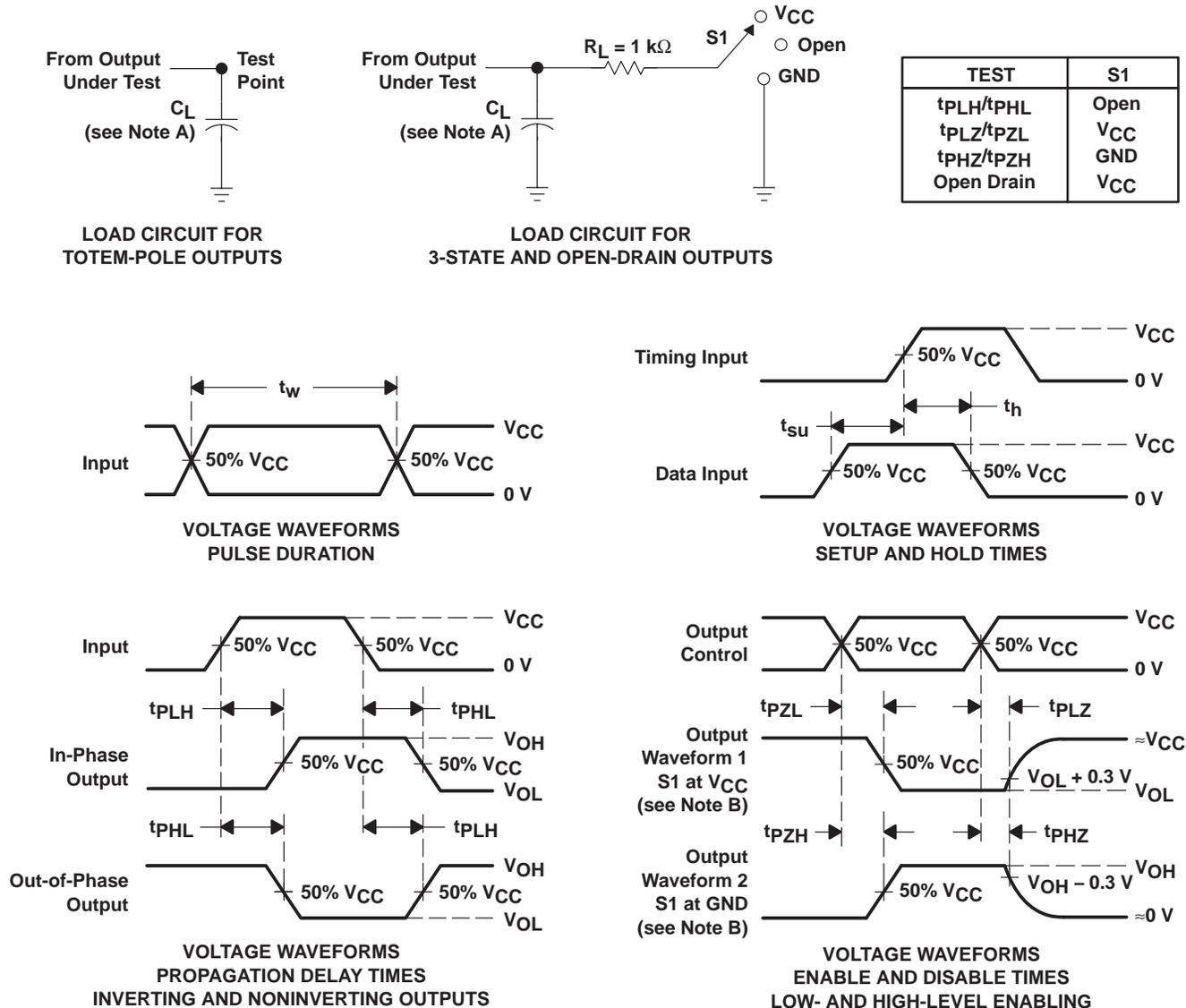
PARAMETER	TEST CONDITIONS	TYP	UNIT
$C_{pd}$ Power dissipation capacitance	$C_L = \text{No load}$ , $CCLK = 10\text{ MHz}$ , $RCLK = 1\text{ MHz}$	56	pF



# SN74LV8154-EP DUAL 16 BIT BINARY COUNTER WITH 3-STATE OUTPUT REGISTERS

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## PARAMETER MEASUREMENT INFORMATION



- NOTES:
- A.  $C_L$  includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq 1\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r \leq 3\text{ ns}$ ,  $t_f \leq 3\text{ ns}$ .
  - D. The outputs are measured one at a time, with one input transition per measurement.
  - E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - G.  $t_{PHL}$  and  $t_{PLH}$  are the same as  $t_{pd}$ .
  - H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuits and Voltage Waveforms

## PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
<a href="#">SN74LV8154MPWREP</a>	Active	Production	TSSOP (PW)   20	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	LV8154ME
SN74LV8154MPWREP.A	Active	Production	TSSOP (PW)   20	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	LV8154ME
<a href="#">V62/06662-01XE</a>	Active	Production	TSSOP (PW)   20	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	LV8154ME

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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### OTHER QUALIFIED VERSIONS OF SN74LV8154-EP :

- Catalog : [SN74LV8154](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

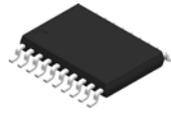
Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LV8154MPWREP	TSSOP	PW	20	2000	330.0	16.4	6.95	7.0	1.4	8.0	16.0	Q1

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

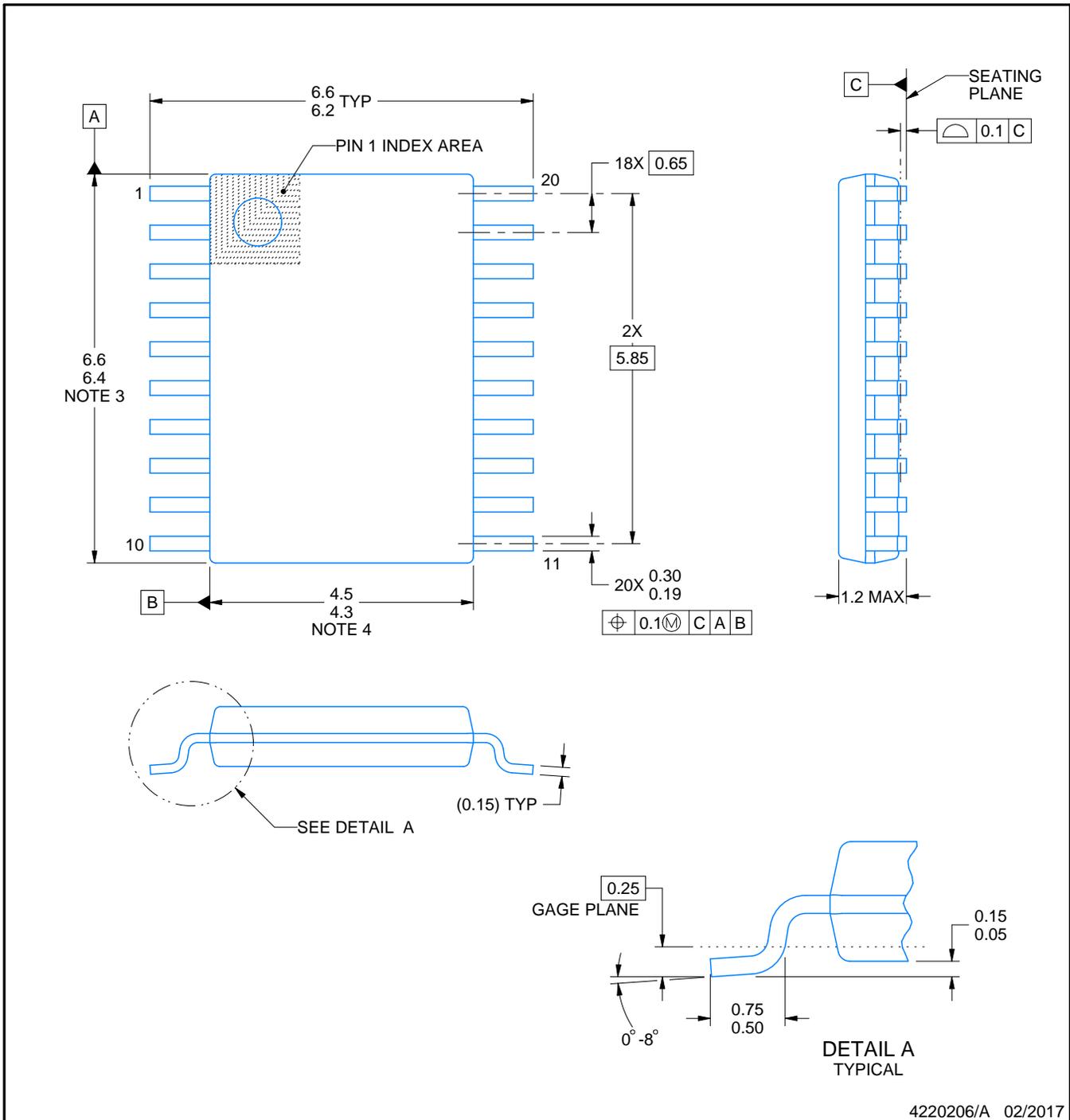
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LV8154MPWREP	TSSOP	PW	20	2000	353.0	353.0	32.0

PW0020A



**PACKAGE OUTLINE**  
**TSSOP - 1.2 mm max height**

SMALL OUTLINE PACKAGE



4220206/A 02/2017

NOTES:

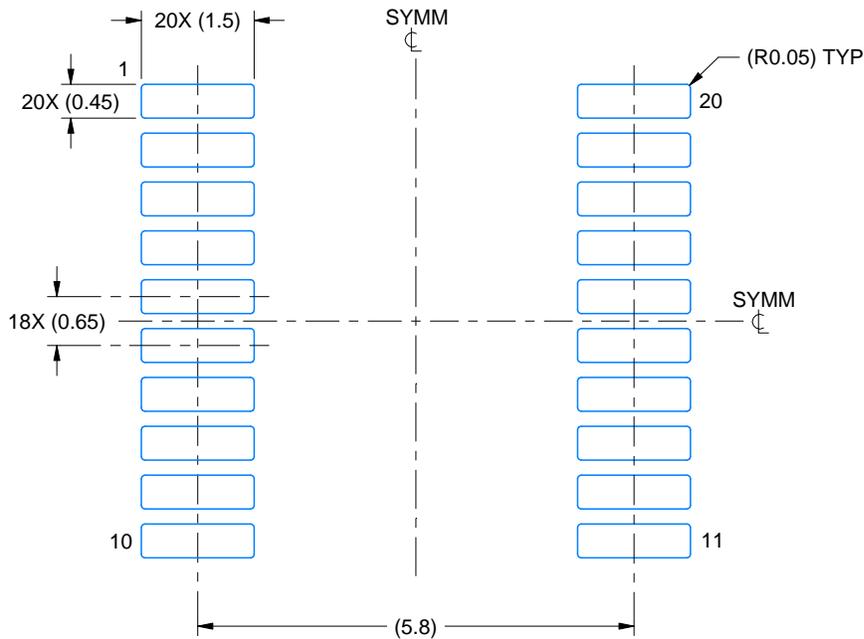
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153.

# EXAMPLE BOARD LAYOUT

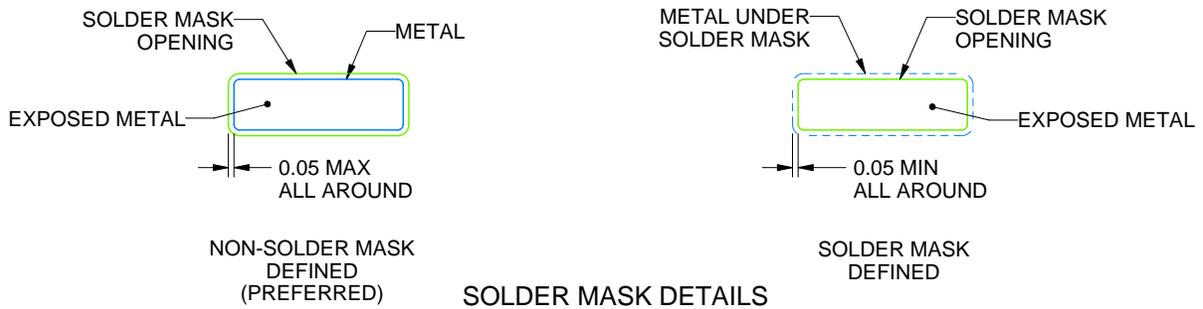
PW0020A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



4220206/A 02/2017

NOTES: (continued)

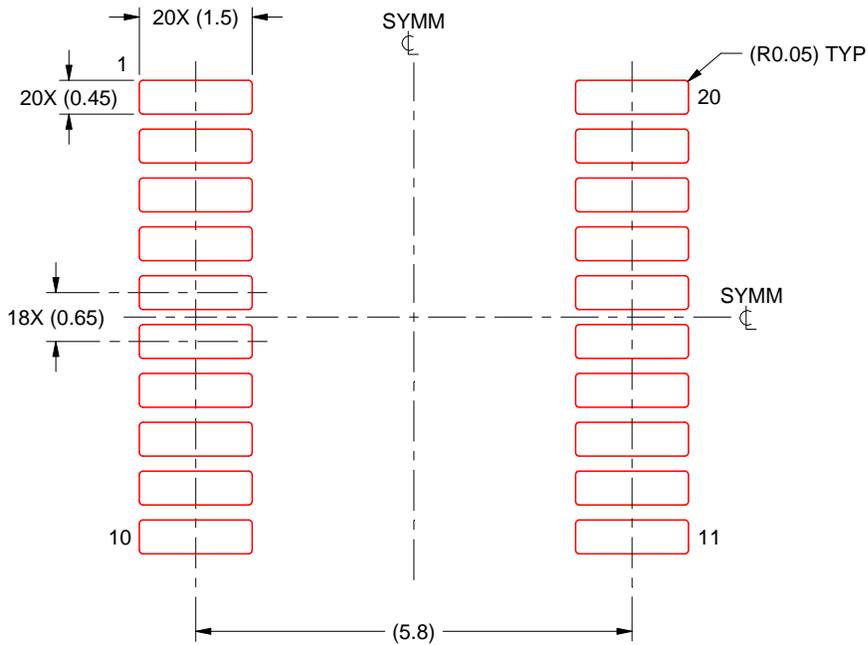
6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

PW0020A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

4220206/A 02/2017

NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.

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